TECHNICAL TAPES

Solder Cover Points, Labels, etc.

KARL SCHUPP AG

CONDUCT – PROTECT – INSULATE



These cover points made of adhesive polyimide (Kapton®) are used in wave soldering and reflow processes. The polysiloxane adhesive ensures clean and safe removal after processing.

Covering points for circuit boards during wave soldering, Temp. Class H (180° C)

Specifications:
Punched parts made of Kapton® (Polyimide, thickness 0.025mm) with Polysiloxane adhesive
Cost-effective, temperature-resistant, removable without residue
Delivered on the rolls of 1,000 pieces, screened (slotted cover for better handling)

Item number	Diameter [mm]	Benefits side by side	Slotted cover	Width[mm]
LP25/040	4	3-lane	no	25
LP25/045	4,5	3-lane	no	25
LP25/050	5	3-lane	no	30
LP25/060	6	3-lane	yes	30
LP25/065	6,5	3-lane	yes	30
LP25/070	7	3-lane	yes	30
LP25/080	8	3-lane	yes	50
LP25/090	9	3-lane	yes	38
LP25/100	10	3-lane	yes	38
LP25/120	12	3-lane	yes	50
LP25/160	16	3-lane	yes	75

Specifications:

Punched parts made of Kapton® (polyimide, thickness 0.050mm) with polysiloxane adhesive on the roll, gridded (slotted cover for better handling, rolls of 1,000 pcs.)

Item number	Diameter [mm]	Benefits side by side	Slotted cover	Width [mm]
LP50/040	4	3-lane	no	25
LP50/045	4,5	3-lane	no	25
LP50/050	5	3-lane	no	30
LP50/060	6	3-lane	yes	30
LP50/065	6,5	3-lane	yes	30
LP50/070	7	3-lane	yes	30
LP50/080	8	3-lane	yes	50
LP50/090	9	3-lane	yes	38
LP50/100	10	3-lane	yes	38
LP50/120	12	3-lane	yes	50
LP50/160	16	3-lane	yes	75

Minimum purchase quantities:

Diameter [mm}		**Diameter [mm}**	
4	10'000 pcs.	8	5'000 pcs.
4,5	10,000 pcs.	9	5'000 pcs.
5	10'000 pcs.	10	5'000 pcs.
6	10'000 pcs.	12	5'000 pcs.
6,5	10'000 pcs.	16	5'000 pcs.
7	10'000 pcs.		